APPLICA	BLE STAN	DARD	USB2.0 SPECIFICATIO			В САВ	LE AND (	CONNE	CTORS SPECIFICATION	ON.	
OPERATING TEMPERATURE F		F RANGE	-30°C TO +85°C STORAGE		-30°C TO +60 °C						
DATING	VOLTAGE		30 V AC	1			SIGNAL ONLY 1.0 A/pin		1.0 A/pin		
RATING				CL	IRRENT		OWER A	DDI V	1.8 A/pin (PIN No.1,N	No.5)	
VOLIA							OWLKA	MEFLI	0.5 A/pin (PIN No.2-N	lo.4)	
			SPE	CIFIC	ATIOI	NS					
ITEM			TEST METHOD	)			REQUIREMENTS			QT	АТ
CONSTR	UCTION	I.								1	1
		VISUALL	VISUALLY AND BY MEASURING INSTRUMENT.			ACCO	RDING T	O DRA	WING.	Χ	Χ
MARKING		CONFIRMED VISUALLY.							X	Х	
ELECTRI	C CHARA	CTERIS	STICS							•	•
		100 mA (DC OR 1000 Hz).			30 mΩ MAX.				X	X	
INSULATION		500 V DC	· ·			1000 N	IΩ MIN.			Х	Х
RESISTANCI VOLTAGE PI						NO FLASHOVER OR BREAKDOWN.				X	X
		100 V AC FOR 1 min. MEASURE ADJACENT TWO CONTACTS AT			Т			K OK E	SKEAKDOWN.	+	
CAPASITAN	CE		Hz AC VOLTAGE.	1170107		2 pF M	IAX.			Х	_
MECHAN	ICAL CHAP	RACTE	RISTICS								
INSERTION A		A MAXIMUM RATE OF 12.5 mm/min.				INSERTION FORCE 35 N MAX.			Х	_	
WITHDRAW	AL FORCES	MEASUR	RED BY APPLICABLE CO	NNECTO	R.	WITHDRAWAL FORCE 8 N MIN.  1) CONTACT RESISTANCE: NO INCREASE			ļ , ,		
		10000 TIMES INSERTIONS AND EXTRACTIONS.			IONS.	OF MORE THAN 10 m $\Omega$ FROM INITIAL					
MECHANICA	J					VALUE.				X	
OPERATION		MATING	-	500 CVCI			2) INSERTION FORCE 35 N MAX. WITHDRAWAL FORCE 8 N MIN.				_
		- MECHANICALLY OPERATED: 500 CYCLES / h - MANUALLY OPERATED: 200 CYCLES / h					B) NO DAMAGE, CRACK AND LOOSENESS, OF PARTS.				
						ĹO					
VIBRATION RANDOM VIBRATION		FREQUENCY 10 TO 55 Hz				<ol> <li>NO ELECTRICAL DISCONTINUITY OF         <ol> <li>μs.</li> </ol> </li> <li>NO DAMAGE, CRACK AND LOOSENESS,</li> </ol>					
		SINGLE AMPLITUDE 0.75 mm, AT 2h FOR 3 AXIAL DIRECTIONS, TOTAL 6h.							Х	_	
		FREQUENCY 50 TO 2000 Hz AT 15 min			OF PARTS.			X			
KANDOW VII	DRATION	FOR 3 AXIAL DIRECTIONS.							_		
		490m/s <sup>2</sup> DURATIONS OF PULSE 11 ms AT 3 TIMES FOR 6 DIRECTIONS, TOTAL 18 TIMES.							Х	_	
FNVIRON	IMFNTAI		ACTERISTICS	712 10 1111	.20.						
	***************************************		55 →15 TO 35→ 85 →	15 TO 35	°C	1) CO	NTACT R	ESIST	ANCE: 70 mΩ MAX.		
THERMAL SI	HOCK	TIME $30 \rightarrow 2 \text{ TO } 3 \rightarrow 30 \rightarrow 2 \text{ TO } 3 \text{ min}$ UNDER 10 CYCLES.			2) INSULATION RESISTANCE: 10 M $\Omega$ MIN.				Х	_	
						3) NO DAMAGE, CRACK AND LOOSENESS, OF PARTS.					
		(MATING APPLICABLE CONNECTOR) TEMPERATURE -10~65 °C, HUMIDITY 90 TO			NO DAMAGE, CRACK AND LOOSENESS,				<u> </u>		
HUMIDITY LIFE  DRY HEAT  COLD			98 %, UNDER 7 CYCLES (168 h)			OF PARTS.			Х	_	
			MATING APPLICABLE CONNECTOR)								<u> </u>
		EXPOSED AT 85±2 °C, 96 h. (MATING APPLICABLE CONNECTOR)			NO DAMAGE, CRACK AND LOOSENESS, OF PARTS.				Х	-	
		EXPOSED AT -40±2 °C , 96 h.			NO DAMAGE, CRACK AND LOOSENESS,				\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		
		(MATING APPLICABLE CONNECTOR)			OF PARTS.			Х			
CORROSION	N SALT MIST		D AT 5 % SALT WATER			NO HE	AVY CO	RROSI	ON OF CONTACTS.	Х	_
001111		l	. (LEFT UNDER UNMATE	-D CONDI		אורה			CHECKED		TE
COUNT	i DE	SCKIPTIC	ON OF REVISIONS		DESIG	INED			CHECKED	DΑ	TE
<u>AA </u> REMARK							APPRO\	VED	NM. NISHIMATSU	15 1	n 27
HIROSE will not guarantee the performance on these specification			ecification	ons in	CHECK		KN. ICHIKAWA		0. 27 0. 27		
case this product will be r			mated with the others which is					TS. ITO		0. 27	
HIROSE's.											
Inless otherwise specified, refer to USB2.0, EIA364 or IEC 60512.					15. 1	0. 27					
Note QT:Qualification Test AT:Assurance Test X:Applicable Test DRAWING NO.				ELC-126189-3	0-00	)					
<b>KS</b> s		PECIFICATION SHEET		PART	NO. ZX62RD-AB-5P8		52RD-AB-5P8 (30)				
11/2			205 51 507512 22 1 75			NO.	CL	242-	0025-0-30	Δ	1/2
ORM HD0011-2-1											

SPECIFICATIONS								
ITEM	TEST METHOD	REQUIREMENTS	QT	АТ				
SOLDERABILITY	SOLDERING POINT IMMERSED IN SOLDER BATH		~					
	OF 255±5°C, 5 sec. (USING TYPE R FLAX)	OF THE SURFACE BEING IMMERSED	^	_				
RESISTANCE TO	A PROFILE IS SHOWN IN FIG-1,	NO DEFORMATION OR SIGNIFICANT	>					
SOLDERING HEAT	UNDER 2 CYCLES.	LOOSENESS OF CONTACTS.	^	_				

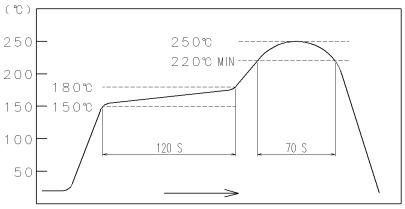


FIG – 1 <u>RESISTANCE TO SOLDERING HEAT</u> (TEMPERATURE AT TOP SURFACE OF CONNECTOR)

## RECOMMENDED PROFILE REFERS TO FIG – 2. (TEMPERATURE AT SMT LEADS)

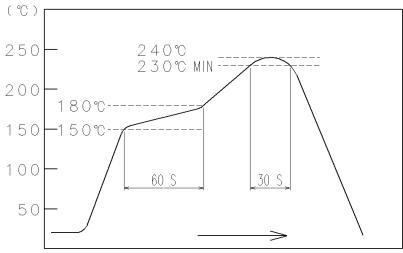


FIG - 2 RECOMMENDED REFLOW PROFILE TEMPERATURE

Note QT:0	Qualification Test AT:Assurance Test X:Applicable Test	DRAWIN	IG NO.	ELC-126189-30-00		
HS.	SPECIFICATION SHEET	PART NO.	ZX62RD-AB-5P8 (30)			
	HIROSE ELECTRIC CO., LTD.	CODE NO	CL242	2-0025-0-30	$\triangle$	2/2